503521758 10/14/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TETSUHIRO TANAKA	09/25/2015
KAZUKI TANEMURA	09/25/2015

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14878121

CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: APSI@fr.com Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

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Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER: 12732-1585001 NAME OF SUBMITTER: JANELLE A. JACKSON SIGNATURE: /Janelle A. Jackson/ **DATE SIGNED:** 10/14/2015

Total Attachments: 1

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PATENT REEL: 036787 FRAME: 0688 503521758

Attorney Docket No. 12732-1585001 Client Reference No. US21349

ASSIGNMENT

For valuable consideration, We, <u>Tetsuhiro TANAKA of Atsugi, Kanagawa, Japan and Kazuki TANEMURA of Atsugi, Kanagawa, Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.,</u> a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE, MODULE, AND
ELECTRONIC DEVICE, filed October 8, 2015 , and assigned U.S. Serial
Number, and we authorize and request the attorneys appointed in said application
to hereafter complete this assignment by inserting above the filing date and serial number of said application
when known; this assignment including said application, any and all United States and foreign patents,
utility models, and design registrations granted for any of said inventions or improvements, and the right to
claim priority based on the filing date of said application under the International Convention for the
Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all
other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its
own name for patents, utility models, design registrations and like rights of exclusion and for inventors'
certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal
representatives and assigns, without further compensation to perform such lawful acts and to sign such
further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may
reasonably request to effectuate fully this assignment.
Signature Tetsyhivo TANAKA
Name: Tetsuhiro TANAKA
Name: Tetsuhiro TANAKA Date: 09/25/20/5
1/ / 1 TO N. G. An
Signature Kazuki TANEMURA
Name: Kazuki TANEMURA
Date: 09/25/2015

RECORDED: 10/14/2015

PATENT REEL: 036787 FRAME: 0689